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Inventors: Hajime Izawa, Yuji Yamamoto, Shinichi Tanaka, Atsumi Wakabayashi, Toru Motoki and Hideki Horikoshi

Assignee: Sumitomo Osaka Cement Co., Ltd.

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For: PAINT FOR FORMING A TRANSPARENT CONDUCTIVE THIN FILM AND TRANSPARENT CONDUCTIVE THIN FILM

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Director of Patents  
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Sir:

Enclosed for filing please find a patent application for an invention entitled, "PAINT FOR FORMING A TRANSPARENT CONDUCTIVE THIN FILM AND TRANSPARENT CONDUCTIVE THIN FILM", filed on behalf of Sumitomo Osaka Cement Co., Ltd., a large entity, and Assignee from Inventors **Hajime Izawa, Yuji Yamamoto, Shinichi Tanaka, Atsumi Wakabayashi, Toru Motoki and Hideki Horikoshi**, said application including:

1. English Translation of patent application consisting of: 14 pages of specification, 1 page of claims, 1 page of Abstract, 1 sheet of drawings figure (original photograph), and 1 page of Abstract;
2. Declaration and Power of Attorney (4pp);

3. Transmittal of Assignment in duplicate (2pp);
4. Recordation Form Cover Sheet and 2 sheets of Assignments (3 pp total);
5. Copy of Published PCT Application (WO 01/32792 A1);
6. Check in the amount of \$690.00 for filing fee;
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The Attorney's Docket Number is SUMI-005.

Kindly address all communications regarding this application to:

Kristin C. Castle  
Sierra Patent Group  
P.O. Box 6149  
Stateline, NV 89449  
Telephone: (775) 586-9500

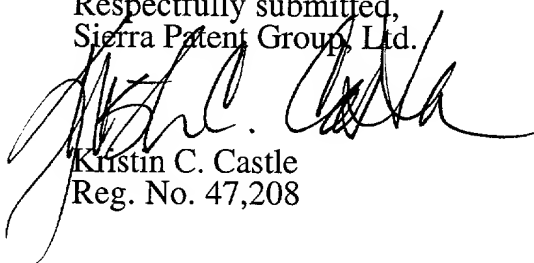
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Date: June 28, 2001

Respectfully submitted,  
Sierra Patent Group, Ltd.



Kristin C. Castle  
Reg. No. 47,208

Sierra Patent Group, Ltd.  
P.O. Box 6149  
Stateline, NV 89449  
(775) 586-9500

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## DESCRIPTION

### PAINT FOR FORMING A TRANSPARENT CONDUCTIVE THIN FILM AND TRANSPARENT CONDUCTIVE THIN FILM

#### Technical Field

The present invention relates to a paint for forming a transparent conductive thin film and a transparent conductive thin film. More specifically, the present invention relates to a paint for forming a transparent conductive thin film which is useful as a coating for transparent material surfaces that require the effects of blocking static electricity, interfering with electromagnetic waves, and the like, such as screen surfaces for display devices, surface covering materials of the same, window glass, show window glass, covering materials for instruments, material for "clean room" floors and walls, packaging materials for semiconductors, and the like; and a transparent conductive thin film obtained by means of coating the aforementioned paint as a transparent thin film.

The present application is based on the corresponding patent application filed in Japan (Japanese Patent Application No. Hei 11-310172); the contents of this Japanese Patent Application are incorporated in part into the present application.

#### Background Art

In general, transparent substrates such as glass substrates used for image display members of CRT display apparatuses, plastic substrates for used as material for "clean room" floors and walls, and the like require treatment for static electricity prevention in order to prevent static electricity blockade. In particular, a conductive thin film to be treated for static electricity prevention is formed onto the surfaces of optical parts such as image display members of CRT display apparatuses, liquid crystal image display members, covering materials for instruments and the like. In order to impart the aforementioned static electricity preventing function without losing the color tone of these optical parts, the aforementioned conductive thin film must comprise a high transparency having a total light permeability of at least 80% and a haze value of no

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greater than 5%, and a conductivity having a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ .

As a treatment method for static electricity prevention, a method is known in which a transparent thin film having conductive properties is formed onto the surface of a transparent substrate such as glass or the like. As the material for forming this type of transparent conductive thin film, a paint for forming a transparent conductive thin film is used which comprises an antimony-doped tin oxide powder having a primary granular diameter of 1 ~ 100 nm, a binder, and a solvent.

According to this conventional method, it is possible to form a thin film having conductive properties stably. However, according to this conventional method, it is extremely difficult to form a thin film having a superior transparency with a total light permeability of at least 80% and a haze value of no greater than 5%. In particular, a transparent conductive thin film formed in accordance with the conventional method does not comprise a sufficient transparency, as a conductive thin film for preventing static electricity, when formed onto the surface of the aforementioned optical parts.

In order to solve the aforementioned problems, the present invention provides a paint which is effective in forming a transparent conductive thin film onto the surface of a transparent material, said transparent conductive thin film possessing a superior transparency and, moreover, a conductivity equal to or greater than that of the conventional transparent conductive thin film, despite the addition of only a small amount of the conductive component; and a transparent conductive thin film formed by means of using the aforementioned paint.

#### Disclosure of Invention

In order to solve the aforementioned problems, the present invention based on Claim 1 provides a paint for forming a transparent conductive thin film characterized in comprising at least: a conductive oxide powder comprising a primary granular diameter of no greater than 100 nm; an easily dispersible low-boiling point solvent of said conductive oxide powder; a difficultly dispersible high-boiling point solvent of said conductive oxide powder; and a binder.

In addition, the present invention based on Claim 2 provides a paint for forming a transparent conductive thin film, wherein said conductive oxide powder is selected from among a tin oxide powder, an antimony-doped tin oxide powder, an indium oxide powder, and a tin-doped indium oxide powder.

Furthermore, the present invention based on Claim 3 provides a paint for forming a transparent conductive thin film, wherein said conductive oxide powder comprises a primary granular diameter of 1 ~ 10 nm, and a secondary granular diameter of 20 ~ 150 nm.

In addition, the present invention based on Claim 4 provides a transparent conductive thin film characterized in having at least one layer comprising a transparent conductive layer which possesses mesh-shaped openings and is formed by means of using said paint for forming a transparent conductive thin film.

In addition, the present invention based on Claim 5 provides a transparent conductive thin film comprising a high transparency having a total light permeability of at least 80% and a haze value of no greater than 5%, and a high conductivity having a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ .

#### Brief Description of the Drawing

Figure 1 is a TEM photograph showing an enlargement of the transparent conductive thin film according to the present invention.

#### Best Mode for Carrying Out the Invention

In the following, the present invention will be further described by means of the preferred embodiments. Furthermore, the preferred embodiments are for the purpose of more effectively explaining the present invention, and hence the present invention is not particularly limited thereto.

#### [Paint for forming a transparent conductive thin film]

The paint for forming a transparent conductive thin film according to the present embodiment comprises at least: a conductive oxide powder comprising a primary granular diameter of no greater than 100 nm; an easily dispersible low-boiling point solvent of said conductive oxide powder; a difficultly dispersible high-boiling point

solvent of said conductive oxide powder; and a binder dissolved in the two aforementioned types of solvents.

Among the two or more types of solvents contained in the paint for forming a transparent conductive thin film, the term "easily dispersible" solvent refers to the solvent which disperse the conductive oxide powder more easily than the other solvent(s). On the other hand, among the two or more types of solvents contained in the paint for forming a transparent conductive thin film, the term "difficultly dispersible" solvent refers to the solvent which disperse the conductive oxide powder more difficultly than the other solvent(s).

In addition, among the two or more types of solvents contained in the paint for forming a transparent conductive thin film, the term "low-boiling point" solvent refers to the solvent which has the lower boiling point than the other solvent(s). And, among the two or more types of solvents contained in the paint for forming a transparent conductive thin film, the term "high-boiling point" solvent refers to the solvent which has the higher boiling point than the other solvent(s). Furthermore, with regard to the "low-boiling point" solvent and "high-boiling point" solvent, a temperature difference of at least 30°C is preferred.

The conductive oxide powder is not particularly limited, as long as it possesses both a superior transparency and conductivity, in addition to a primary granular diameter of no greater than 100 nm. Appropriate examples of this conductive oxide powder include a tin oxide powder, an antimony-doped tin oxide (hereinafter referred to as "ATO") powder, an indium oxide powder, and a tin-doped indium oxide powder. Among the aforementioned, from the perspective of transparency and conductivity, in particular, the ATO powder may be appropriately used.

In addition, the conductive oxide powder preferably comprises a primary granular diameter of 1 ~ 10 nm, and a secondary granular diameter of 20 ~ 150 nm. In the case when using a conductive oxide powder comprising a primary granular diameter and secondary granular diameter within the aforementioned ranges, a transparent conductive thin film having both a superior transparency and conductivity can be easily formed.

In other words, when the primary granular diameter is less than 1 nm, the contact resistivity increases due to an increase in the number of contact points among the primary

granules. As a result, the conductivity of the aforementioned paint decreases, and the granules tend to aggregate easily, such that formation of secondary granules, in the aforementioned paint, having diameters within the aforementioned range is not possible. In addition, a primary granular diameter exceeding 10 nm results in degradation of the transparency of the resultant conductive thin film, such that obtaining a transparency with a total light permeability of at least 80% and a haze value of no greater than 5% becomes difficult.

The conductive oxide powder may also undergo various surface processing, for example, hydrophilic processing or non-hydrophilic processing, wherein the combination of solvents used must be appropriately selected, as described below, depending on the surface treatment conditions.

The concrete examples of the "easily dispersible low-boiling point solvent of the conductive oxide powder" differ depending on the surface conditions of the conductive oxide powder to be used.

In other words, when the conductive oxide powder to be used comprises a hydrophilic powder, examples of the easily dispersible low-boiling point solvent of the conductive oxide powder may include water (boiling point 100°C), methanol (boiling point 65°C), ethanol (boiling point 78°C), 2-propanol (boiling point 82°C), 1-propanol (boiling point 97°C), and the like.

In addition, when the conductive oxide powder to be used comprises a non-hydrophilic powder, examples of the easily dispersible low-boiling point solvent of the conductive oxide powder may include acetone (boiling point 56°C), methylethyl ketone (boiling point 80°C), methylisobutyl ketone (boiling point 116°C), diethyl ketone (boiling point 102°C), tetrahydrofuran (boiling point 66°C), methyl formate (boiling point 32°C), ethyl formate (boiling point 54°C), methyl acetate (boiling point 58°C), ethyl acetate (boiling point 77°C), and the like.

The concrete examples of the "difficultly dispersible high-boiling point solvent of the conductive oxide powder" also differ depending on the surface conditions of the conductive oxide powder to be used.

In other words, when the conductive oxide powder to be used comprises a hydrophilic powder, examples of the difficultly dispersible high-boiling point solvent of

the conductive oxide powder may include 1-ethoxy-2-propanol (boiling point 132°C), 1-methoxy-2-propanol (boiling point 120°C), 2-methoxyethyl acetate (boiling point 145°C), 2-ethoxyethyl acetate (boiling point 156°C), 2-butoxyethyl acetate (boiling point 191°C), tetrahydrofurfuryl alcohol (boiling point 178°C), propylene carbonate (boiling point 242°C), N, N-dimethyl formamide (boiling point 153°C), N-methylformamide (boiling point 180°C), N-methyl pyrrolidone (boiling point 202°C), 2-ethoxy ethanol (boiling point 136°C), 2-butoxy ethanol (boiling point 170°C) and the like.

In addition, when the conductive oxide powder to be used comprises a non-hydrophilic powder, examples of the difficultly dispersible high-boiling point solvent of the conductive oxide powder may include toluene (boiling point 110°C), xylene (boiling point 138 ~ 144°C), ethyl benzene (boiling point 136°C), isophorone (boiling point 215°C), cyclohexanone (boiling point 156°C), 2-ethoxy ethanol (boiling point 136°C), 2-butoxy ethanol (boiling point 170°C), and the like.

The aforementioned binder is not particularly limited and may comprise any binder which is soluble in the aforementioned two or more types of solvents, as long as a thin film possessing a superior durability is obtainable. Examples of this binder may include acrylic resins such as methacrylic resins and the like, polyacetylene resins, amino resins such as melamine resins and the like, polyamide resins, polyimide resins, polyamide-imide resins, polyethylene resins, polycarbonate resins, polyurethane resins, polyester resins such as alkyd resins and the like, epoxy resins, polystyrene resins, ABS resins, polyamidesulfone resins, polyethersulfone resins, vinyl chloride resins, vinylidene chloride resins, vinyl acetate resins, polyvinyl alcohol resins, silicone resins, fluorine resins, polyphenylene oxide resins, polypyrrole resins, ultraviolet ray cure resins, cellulose derivatives such as diacetyl cellulose, triacetyl cellulose and the like. The aforementioned binders may be used alone or in combinations of two or more.

The blending ratios of each component in the paint for forming a transparent conductive thin film is not particularly limited, but may comprise, for example, 0.6 ~ 12% by weight of the conductive oxide powder granules, 1 ~ 25% by weight of the binder, with the remainder comprising at least two type of solvents.



When using a paint for forming a transparent conductive thin film having the aforementioned blending ratios, it is possible to easily obtain a transparent conductive thin film comprising a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ , a total light permeability of at least 80%, and a haze value of no greater than 5%. In particular, in the case when ATO powder is used as the conductive oxide powder, it is possible to easily obtain a transparent conductive thin film comprising a surface resistivity of  $1 \times 10^6 \sim 9 \times 10^{11} \Omega/\square$ , a total light permeability of at least 85%, and a haze value of no greater than 0.5%.

In addition, among the two or more types of solvents, the blending ratio of the “easily dispersible low-boiling point solvent of said conductive oxide powder” and “difficultly dispersible high-boiling point solvent of said conductive oxide powder” comprises a weight ratio of 95:5 ~ 60:40. This weight ratio allows for the easy formation of a conductive oxide powder, within the aforementioned paint, comprising secondary granules having a granular diameter of 20 ~ 150 nm, and results in a superior conductivity and transparency, in addition to a superior paint dispersion stability and easy coating properties.

In addition, the paint for forming a transparent conductive thin film according to the present embodiment may be prepared from a conductive oxide powder, an easily dispersible low-boiling point solvent of said conductive oxide powder, a difficultly dispersible high-boiling point solvent of said conductive oxide powder, and a binder, in addition to adding and mixing in, as necessary, additives such as a dispersing agent, viscosity controlling agent, surface improving agent, and the like according to the appropriate conventional method.

At the same time, it is also possible to appropriately add a third solvent in addition to the easily dispersible low-boiling point solvent of said conductive oxide powder, and difficultly dispersible high-boiling point solvent of said conductive oxide powder.

#### [Transparent Conductive Thin Film]

A transparent conductive thin film having mesh-shaped openings is obtained by means of coating the aforementioned paint for forming a transparent conductive thin film

onto a substrate surface such as glass, plastic or the like, and then drying, curing, and forming a thin film onto the substrate surface.

Here, any conventional method may be used to coat the paint for forming a transparent conductive thin film onto the surface of the substrate: for example, spin coating, dip coating, spray coating, flow coating, bar coating, gravure coating, or the like may be used. The drying temperature is not in particular limited, as long as the temperature allows for the evaporation of the solvents used.

It is not always clear why a transparent conductive thin film having both a superior transparency and conductivity is formed using the paint for forming a transparent conductive thin film, however, a hypothesis for the aforementioned is described below. In other words, when the film coat formed using the paint for forming a transparent conductive thin film is dried, the easily dispersible low-boiling point solvent of said conductive oxide powder is evaporated off, which in turn results in the gentle aggregation of the conductive oxide powder into a mesh form. This aggregate, while maintaining the aforementioned mesh structure, is then solidified onto the substrate via the binder with the evaporation of the difficultly dispersible high-boiling point solvent of said conductive oxide powder to form the transparent conductive thin film having mesh-shaped openings, as shown in Figure 1 (TEM photograph, 500,000× enlargement).

As a result, despite adding only a small amount of the conductive component, it is possible to form an excellent conductive pass, and moreover, achieve an excellent transparency by means of the mesh-shaped openings.

### Examples

In the following, the present invention will be further described by means of the Examples.

#### (Experimental Example)

As the conductive oxide powder, 0.01 g of an ATO powder (non-hydrophilic, manufactured by Sumitomo Osaka Cement, Inc.) comprising a primary granular diameter of 3 ~ 8 nm, was respectively dispersed into 5.0 g of methylethyl ketone, diacetone alcohol, cyclohexanone, and toluene as the solvents. The secondary granular diameters

of the ATO powder in these dispersed solvents were then measured using a laser diffraction method, and the dispersibility of the ATO powder was evaluated. These results are shown in Table 1.

(Example 1)

0.20 g of the ATO powder used in the Experimental Example above, 17.00 g of methylethyl ketone, 2.00 g of cyclohexanone and 0.80 g of a polyester resin (brand name Eliter, manufactured by Yunchika, K.K.) were mixed together as the conductive oxide powder, easily dispersible low-boiling point solvent of said ATO powder, difficultly dispersible high-boiling point solvent of said ATO powder, and binder, respectively. The mixture was then dispersed using an ultrasound dispersing device to yield a paint for forming a transparent conductive thin film of Example 1.

The secondary granular diameters of the ATO powder within the transparent conductive paint were then measured using a laser diffraction method (PHOTON CORRELATOR LPA-3000 manufactured by Otsuka Electron, Inc.). These results are shown in Table 2.

The paint for forming the transparent conductive thin film of Example 1 was then coated onto a polyethylene terephthalate film at room temperature using a bar coater (#7), and dried for 10 minutes under a temperature of 100°C to form the transparent conductive thin film.

Subsequently, the total light permeability, haze value, and surface resistivity of the resultant transparent conductive thin film were each measured by the following methods and devices. These results are shown in Table 2.

Total light permeability: HAZE METER MODEL TC-H3DPK manufactured by Tokyo Denshoku, K.K.

Haze value: Same as above

Surface resistivity: Loresta IP manufactured by Mitsubishi Chemicals, Inc.

In addition, the film structure of this transparent conductive thin film was observed under an electron microscope to verify the formation of a plurality of mesh-shaped openings.

(Example 2)

A paint for forming the transparent conductive thin film of Example 2 was prepared in the same manner as Example 1, with the exception of the blending amounts of the ATO powder, methylethyl ketone, cyclohexanone and binder, which were 2.4 g, 12.00 g, 2.00 g, and 3.60 g, respectively.

The secondary granular diameters of the ATO powder within the transparent conductive paint were then measured in the same manner as in Example 1. These results are shown in Table 2.

In the same manner as in Example 1, a transparent conductive thin film was then formed from the above paint for forming the transparent conductive thin film of Example 2. Subsequently, the total light permeability, haze value, and surface resistivity of the resultant transparent conductive thin film were each measured in the same manner as in Example 1. These results are shown in Table 2.

In addition, the film structure of this transparent conductive thin film was observed under an electron microscope to verify the formation of a plurality of mesh-shaped openings.

(Example 3)

A paint for forming the transparent conductive thin film of Example 3 was prepared in the same manner as Example 1, with the exception of the blending amounts of methylethyl ketone and cyclohexanone which were 13.00 g and 6.00 g, respectively.

The secondary granular diameters of the ATO powder within the transparent conductive paint were then measured in the same manner as in Example 1. These results are shown in Table 2.

In the same manner as in Example 1, a transparent conductive thin film was then formed from the above paint for forming the transparent conductive thin film of Example 3. Subsequently, the total light permeability, haze value, and surface resistivity of the resultant transparent conductive thin film were each measured in the same manner as in Example 1. These results are shown in Table 2.

In addition, the film structure of this transparent conductive thin film was observed under an electron microscope to verify the formation of a plurality of mesh-shaped openings.

(Comparative Example 1)

The paint for forming the transparent conductive thin film of Comparative Example 1 was prepared in the same manner as Example 1, with the exception that only 19.00 g of methylethyl ketone was used as the solvent.

The secondary granular diameters of the ATO powder within the transparent conductive paint were then measured in the same manner as in Example 1. These results are shown in Table 2.

In the same manner as in Example 1, a transparent conductive thin film was then formed from the above paint for forming the transparent conductive thin film of Comparative Example 1. Subsequently, the total light permeability, haze value, and surface resistivity of the resultant transparent conductive thin film were each measured in the same manner as in Example 1. These results are shown in Table 2.

In addition, upon viewing the film structure of this transparent conductive thin film under an electron microscope, there was no formation of any mesh-shaped openings.

(Comparative Example 2)

An attempt was made to prepare the paint for forming the transparent conductive thin film of Comparative Example 2 in the same manner as Example 1, with the exception that only 19.00 g of cyclohexanone was used as the solvent. However, precipitates of ATO aggregates formed, such that coating was not possible.

Table 1

Solvent Name	Boiling point (°C)	Secondary granular diameter (nm)	ATO dispersibility
Methylethyl ketone	79.64	51	Excellent
Diacetone alcohol	168.10	40	Excellent
Cyclohexanone	155.65	-	Poor (precipitation)
Toluene	110.63	-	Poor (precipitation)

Table 2

	Secondary granular diameter (nm)	Total light permeability (%)	Haze value (%)	Surface resistivity ( $\Omega/$ )
Example 1	113	95.3	0.2	$2.7 \times 10^{10} \sim 6.5 \times 10^{10}$
Example 2	133	87.1	0.4	$3.8 \times 10^8 \sim 5.7 \times 10^8$
Example 3	130	92.8	0.3	$1.1 \times 10^{10} \sim 3.3 \times 10^{10}$
Comparative Example 1	98	95.5	0.2	$8.8 \times 10^{12} \sim 22 \times 10^{12}$
Comparative Example 2	-	-	-	-

Note: In Examples 1 ~ 3, due to the inclusion of a binder in the paint, the secondary granular diameters were larger than the secondary granular diameters of the Experimental Example.

### Industrial Applicability

According to the paint for forming a transparent conductive thin film based on Clam 1, which is characterized in comprising at least a conductive oxide powder comprising a primary granular diameter of no greater than 100 nm, an easily dispersible low-boiling point solvent of said conductive oxide powder, a difficultly dispersible high-boiling point solvent of said conductive oxide powder, and a binder, it is possible to obtain a paint for forming a transparent conductive thin film by means of which a transparent conductive thin film possessing a superior conductivity and transparency may be formed despite the addition of only a small amount of the conductive component.

According to the paint for forming a transparent conductive thin film based on Clam 2, wherein said conductive oxide powder is selected from among a tin oxide powder, an antimony-doped tin oxide powder, an indium oxide powder, and a tin-doped indium oxide powder, it is possible to impart both a superior transparency and conductivity.

According to the paint for forming a transparent conductive thin film based on Clam 3, it is possible to impart both a superior transparency and conductivity since the conductive oxide powder comprises a primary granular diameter of 1 ~ 10 nm, and a secondary granular diameter of 20 ~ 150 nm.

In addition, according to the transparent conductive thin film based on Clam 4, by means of incorporating at least one layer comprising a transparent conductive layer which possesses mesh-shaped openings and is formed by means of using said paint for forming a transparent conductive thin film based on Clam 1, it is possible to form an excellent conductive pass despite the addition of only a small amount of the conductive component, and obtain an excellent transparency from the mesh-shaped openings.

In this manner, by means of coating, drying and curing the paint for forming a transparent conductive thin film based on Clam 1 onto the surface of a substrate, such as glass, plastic or the like, it is possible to form a superior transparent conductive thin film comprising a plurality of mesh-shaped openings, which has transparency of a total light permeability of at least 80% and a haze value of no greater than 5%, and a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ .

Consequently, it is possible to form a transparent conductive thin film which is useful as a coating for transparent material surfaces that require the effects of blocking static electricity, interfering with electromagnetic waves, and the like, such as screen surfaces for display devices, surface covering materials of the same, window glass, show window glass, covering materials for instruments, material for "clean room" floors and walls, packaging materials for semiconductors, and the like, and thus also broaden the spectrum of use for such transparent conductive thin films.

The transparent conductive thin film based on Claim 5 comprises a total light permeability of at least 80%, a haze value of no greater than 5%, and a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ , and as a result, it is possible to obtain a film having both a high conductivity and a high transparency.

Furthermore, the present invention has been described by means of the Claims, but is in no manner limited to just the contents of the present description. In addition, the present invention also includes modifications and changes based on the Claims of the present invention.



## Claims

1. A paint for forming a transparent conductive thin film characterized in comprising at least: a conductive oxide powder comprising a primary granular diameter of no greater than 100 nm; an easily dispersible low-boiling point solvent of said conductive oxide powder; a difficultly dispersible high-boiling point solvent of said conductive oxide powder; and a binder.
2. A paint for forming a transparent conductive thin film according to Claim 1, wherein said conductive oxide powder is selected from among a tin oxide powder, an antimony-doped tin oxide powder, an indium oxide powder, and a tin-doped indium oxide powder.
3. A paint for forming a transparent conductive thin film according to Claim 1, wherein said conductive oxide powder comprises a primary granular diameter of 1 ~ 10 nm, and a secondary granular diameter of 20 ~ 150 nm.
4. A transparent conductive thin film characterized in having at least one layer comprising a transparent conductive layer which possesses mesh-shaped openings and is formed by means of using said paint for forming a transparent conductive thin film according to Claim 1.
5. A transparent conductive thin film according to Claim 4 comprising a total light permeability of at least 80%, a haze value of no greater than 5%, and a surface resistivity of no greater than  $9 \times 10^{11} \Omega/\square$ .

## Abstract

The present invention relates to a paint for forming a transparent conductive thin film characterized in comprising at least a conductive oxide powder comprising a primary granular diameter of no greater than 100 nm; an easily dispersible low-boiling point solvent of the aforementioned conductive oxide powder; a difficultly dispersible high-boiling point solvent of the aforementioned conductive oxide powder; and a binder. By using the paint for forming a transparent conductive thin film, it is possible to form a transparent conductive thin film having superior transparency and conductive properties onto the surface of a transparent material. The present invention also provides a paint for forming a transparent conductive thin film which is useful as a coating for transparent material surfaces that require the effects of blocking static electricity, interfering with electromagnetic waves, and the like, such as screen surfaces for display devices, surface covering materials of the same, window glass, show window glass, covering materials for instruments, materials for "clean room" floors and walls, packaging materials for semiconductors, and the like; and a transparent conductive thin film obtained by means of coating the aforementioned paint as a transparent thin film.

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FIG. 1

## DECLARATION & POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My correct residence, post office address and citizenship are stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

PAINT FOR FORMING A TRANSPARENT CONDUCTIVE THIN FILM  
AND TRANSPARENT CONDUCTIVE THIN FILM

The specification of this subject matter:

is attached hereto.

was filed on October 23, 2000 ; PCT International Application  
No. PCT/JP00/07379

was assigned serial No. ;

which was amended on \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above-identified patent application, including the claims, as amended by any amendment(s) referred to above. I do not know and do not believe that the claimed invention was ever known or used in the United States of America before my invention thereof, or patented or described in any printed publication in any country before my invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, and that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months (for a utility patent application) or six months (for a design patent application) prior to this application.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 C.F.R. §1.56(a).

I hereby claim foreign priority benefits under 35 U.S.C. §119 (a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)			Priority Claimed	
Patent 11-310172	Japan	10/29/1999	X	
Number	Country	Month/Day/Year Filed	Yes	No
Number	Country	Month/Day/Year Filed	Yes	No
Number	Country	Month/Day/Year Filed	Yes	No

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below:

Application Number	Filing Date
--------------------	-------------

Application Number	Filing Date
--------------------	-------------

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in these prior United States application(s) in the manner provided by 35 U.S.C. §112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. §1.56(a) which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application.

Application No.	Filing Date	Status (Issued, Pending, Abandoned)
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Application No.	Filing Date	Status (Issued, Pending, Abandoned)
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Application No.	Filing Date	Status (Issued, Pending, Abandoned)
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5/23/99  
I hereby appoint Kenneth D'Alessandro, Registration No. 29,144; Timothy Brisson, Registration No.: 44,046; Andrew V. Smith, Registration No.: 43,132; Seong-Kun Oh, Recognition under 37 C.F.R. § 10.9(b), and Michael A. Blake, Registration No.: 42,333, and Nancy Lord Johnson Registration No.: 45,462 and all Registered Attorneys and Registered Agents of Sierra Patent Group, Ltd. as attorneys of record with full power of substitution and revocation, to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith, and certifies that it is the assignee of the entire right, title and interest in the patent application identified above by virtue of an assignment, a copy of which is attached, from the inventor(s) of the patent application identified above.

Please send all correspondence and direct all telephone calls to:

Kenneth D'Alessandro  
Sierra Patent Group, Ltd.  
P.O. Box 6149  
Stateline, NV 89449  
Telephone (775) 586-9500

I, the undersigned, declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing therefrom.

1-00

FULL NAME OF INVENTOR 1	FIRST Name	MIDDLE Initial(s)	LAST Name
	<u>Hajime</u>		<u>Izawa</u>
RESIDENCE AND City	State or Foreign Country	Country of Citizenship	
<u>Japanese</u>	<u>Funabashi-shi, Japan</u>	<u>JPX Japan</u>	
POST OFFICE ADDRESS	Number and Street	City	State or Country Zip Code
<u>c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,</u>			
<u>585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan</u>			

2-00

FULL NAME OF INVENTOR 2	FIRST Name	MIDDLE Initial(s)	LAST Name
	<u>Yuji</u>		<u>Yamamoto</u>
RESIDENCE AND City	State or Foreign Country	Country of Citizenship	
<u>Japanese</u>	<u>Funabashi-shi, Japan</u>	<u>JPX Japan</u>	
POST OFFICE ADDRESS	Number and Street	City	State or Country Zip Code
<u>c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,</u>			
<u>585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan</u>			

3-00

FULL NAME OF INVENTOR 3	FIRST Name	MIDDLE Initial(s)	LAST Name
	<u>Shin-ichi</u>		<u>Tanaka</u>
RESIDENCE AND City	State or Foreign Country	Country of Citizenship	
<u>Japanese</u>	<u>Funabashi-shi, Japan</u>	<u>JPX Japan</u>	
POST OFFICE ADDRESS	Number and Street	City	State or Country Zip Code
<u>c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,</u>			
<u>585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan</u>			

4-00

FULL NAME OF INVENTOR 4	FIRST Name	MIDDLE Initial(s)	LAST Name
	<u>Atsumi</u>		<u>Wakabayashi</u>
RESIDENCE AND City	State or Foreign Country	Country of Citizenship	
<u>Japanese</u>	<u>Funabashi-shi, Japan</u>	<u>JPX Japan</u>	
POST OFFICE ADDRESS	Number and Street	City	State or Country Zip Code
<u>c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,</u>			
<u>585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan</u>			

5-00

FULL NAME OF INVENTOR 5	FIRST Name	MIDDLE Initial(s)	LAST Name
	<u>Toru</u>		<u>Motoki</u>
RESIDENCE AND City	State or Foreign Country	Country of Citizenship	
<u>Japanese</u>	<u>Funabashi-shi, Japan</u>	<u>JPX Japan</u>	
POST OFFICE ADDRESS	Number and Street	City	State or Country Zip Code
<u>c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,</u>			
<u>585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan</u>			

LAST Name

Horikoshi

Country of Citizenship

Japan

Zip Code

c/o SUMITOMO OSAKA CEMENT CO., LTD., ADVANCED MATERIALS DIVISION,

585, Toyotomi-cho, Funabashi-shi, Chiba-ken, Japan

I further declare that all statements made herein of my own knowledge are true and that all statements made upon information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

June 20, 2001

Date

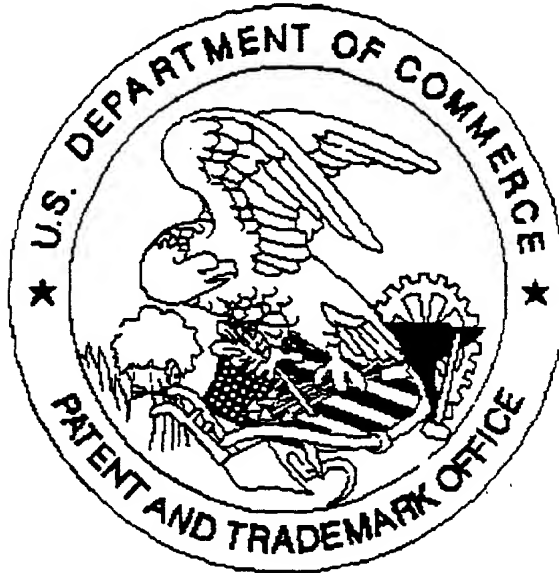
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